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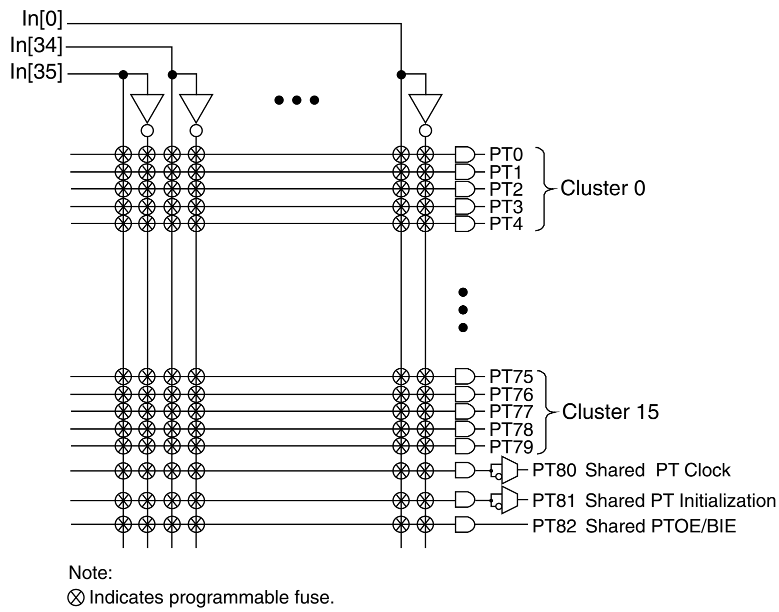
Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Active
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	1.7V ~ 1.9V
Number of Logic Elements/Blocks	2
Number of Macrocells	32
Number of Gates	-
Number of I/O	32
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	64-TFBGA, CSPBGA
Supplier Device Package	64-CSBGA (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4032ze-7mn64c

Figure 3. AND Array



Enhanced Logic Allocator

Within the logic allocator, product terms are allocated to macrocells in product term clusters. Each product term cluster is associated with a macrocell. The cluster size for the ispMACH 4000ZE family is 4+1 (total 5) product terms. The software automatically considers the availability and distribution of product term clusters as it fits the functions within a GLB. The logic allocator is designed to provide two speed paths: 20-PT Speed Locking path and an up to 80-PT path. The availability of these two paths lets designers trade timing variability for increased performance.

The enhanced Logic Allocator of the ispMACH 4000ZE family consists of the following blocks:

- Product Term Allocator
- Cluster Allocator
- Wide Steering Logic

Figure 4 shows a macrocell slice of the Logic Allocator. There are 16 such slices in the GLB.

Figure 4. Macrocell Slice

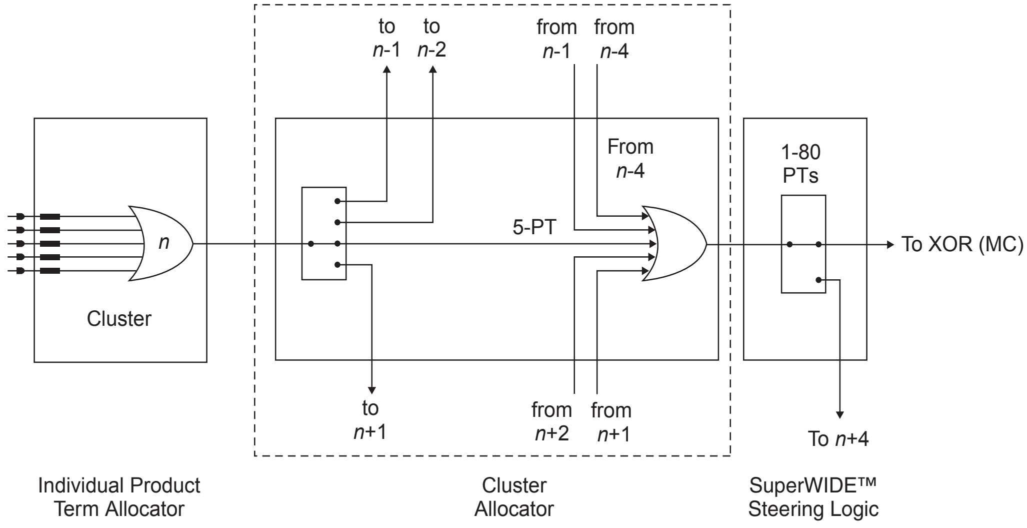
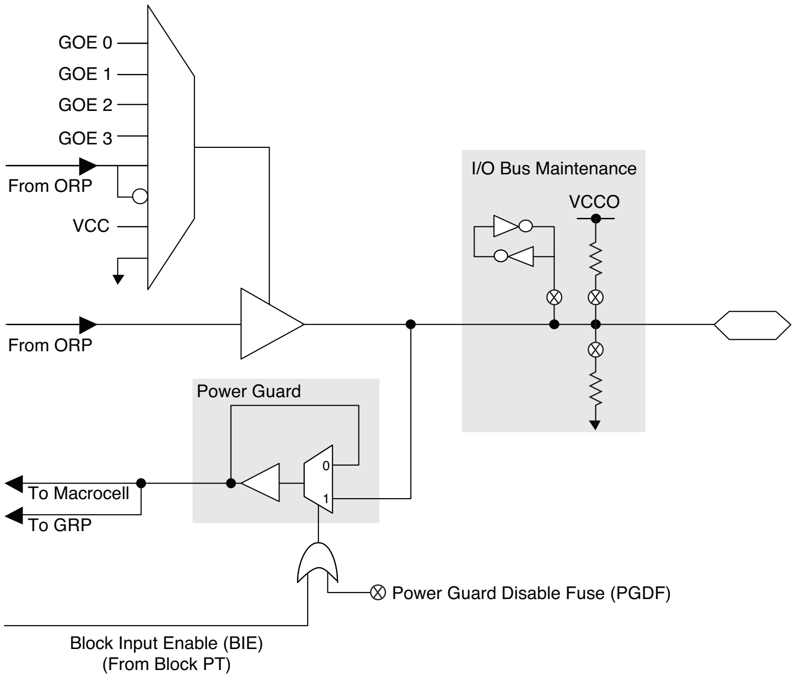


Figure 8. I/O Cell



Each output supports a variety of output standards dependent on the V_{CCO} supplied to its I/O bank. Outputs can also be configured for open drain operation. Each input can be programmed to support a variety of standards, independent of the V_{CCO} supplied to its I/O bank. The I/O standards supported are:

- LVTTL
- LVCMOS 3.3
- LVCMOS 2.5
- LVCMOS 1.8
- LVCMOS 1.5
- 3.3V PCI Compatible

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, pull-up resistor or pull-down resistor selectable on a “per-pin” basis. A fourth option is to provide none of these. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-down Resistor.

Each ispMACH 4000ZE device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

The ispMACH 4000ZE family has an always on, 200mV typical hysteresis for each input operational at 3.3V and 2.5V. This provides improved noise immunity for slow transitioning signals.

Power Guard

Power Guard allows easier achievement of standby current in the system. As shown in Figure 9, this feature consists of an enabling multiplexer between an I/O pin and input buffer, and its associated circuitry inside the device.

If the enable signal (E) is held low, all inputs (D) can be optionally isolated (guarded), such that, if any of these were toggled, it would not cause any toggle on internal pins (Q), thus, a toggling I/O pin will not cause any internal dynamic power consumption.

Some Simple Use Scenarios

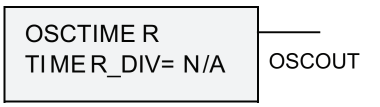
The following diagrams show a few simple examples that omit optional signals for the OSCTIMER block:

A. An oscillator giving 5MHz nominal clock

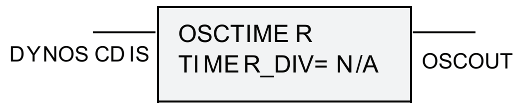
B. An oscillator that can be disabled with an external signal (5MHz nominal clock)

C. An oscillator giving approximately 5 Hz nominal clock (TIMER_DIV = 2^{20} (1,048,576))

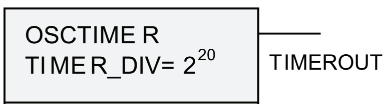
D. An oscillator giving two output clocks: ~5MHz and ~5KHz (TIMER_DIV= 2^{10} (1,024))



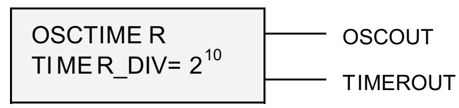
(A) A simple 5MHz oscillator.



(B) An oscillator with dynamic disable.



(C) A simple 5Hz oscillator.



(D) Oscillator with two outputs (5MHz and 5KHz).

OSCTIMER Integration With CPLD Fabric

The OSCTIMER is integrated into the CPLD fabric using the Global Routing Pool (GRP). The macrocell (MC) feedback path for two macrocells is augmented with a programmable multiplexer, as shown in Figure 15. The OSCTIMER outputs (OSCOUT and TIMEROUT) can optionally drive the GRP lines, whereas the macrocell outputs can drive the optional OSCTIMER inputs TIMERRES and DYNOSCDIS.

Figure 15. OSCTIMER Integration With CPLD Fabric

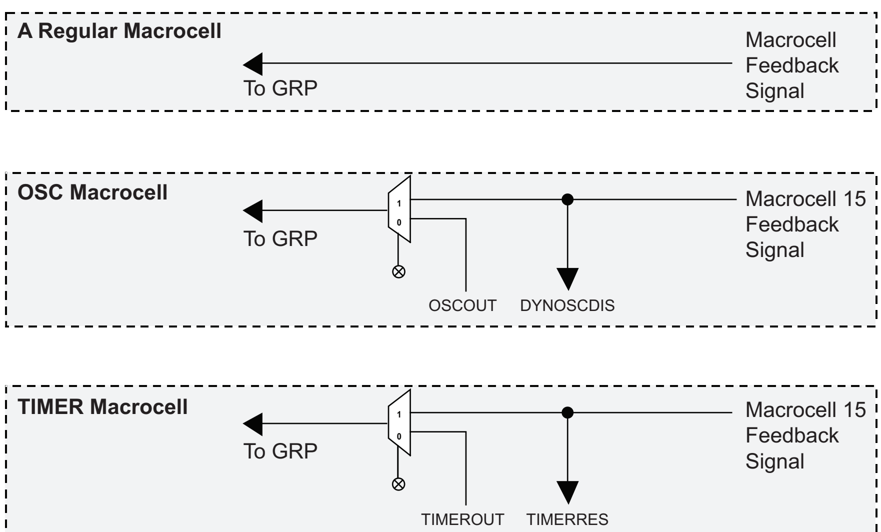


Table 12 shows how these two MCs are designated in each of the ispMACH4000ZE device.

Supply Current

To minimize transient current during power-on, configure CPLD I/Os to a pull-up or float state. If this logic scenario is not possible, then the recommended power sequence should assert VCC and VCCO at the same time or VCC before VCCO.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
ispMACH 4032ZE						
ICC[1, 2, 3, 5, 6]	Operating Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	50	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	58	—	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	60	—	µA
ICC[4, 5, 6]	Standby Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	10	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	13	25	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	15	40	µA
ispMACH 4064ZE						
ICC[1, 2, 3, 5, 6]	Operating Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	80	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	89	—	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	92	—	µA
ICC[4, 5, 6]	Standby Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	11	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	15	30	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	18	50	µA
ispMACH 4128ZE						
ICC[1, 2, 3, 5, 6]	Operating Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	168	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	190	—	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	195	—	µA
ICC[4, 5, 6]	Standby Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	12	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	16	40	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	19	60	µA
ispMACH 4256ZE						
ICC[1, 2, 3, 5, 6]	Operating Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	341	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	361	—	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	372	—	µA
ICC[4, 5, 6]	Standby Power Supply Current	Vcc = 1.8V, T_A = 25°C	—	13	—	µA
		Vcc = 1.9V, T_A = 0 to 70°C	—	32	65	µA
		Vcc = 1.9V, T_A = -40 to 85°C	—	43	100	µA

1. Frequency = 1.0 MHz.
2. Device configured with 16-bit counters.
3. I_{CC} varies with specific device configuration and operating frequency.
4. V_{CCO} = 3.6V, V_{IN} = 0V or $V_{CCO,}$ bus maintenance turned off. V_{IN} above V_{CCO} will add transient current above the specified standby I_{CC}.
5. Includes V_{CCO} current without output loading.
6. This operating supply current is with the internal oscillator disabled. Enabling the internal oscillator adds approximately 15µA typical current plus additional current from any logic it drives.

ispMACH 4000ZE External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description[1, 2]	LC4032ZE -4 Min.	LC4032ZE -4 Max.	LC4064ZE -4 Min.	LC4064ZE -4 Max.	All Devices -5 Min.	All Devices -5 Max.	All Devices -7 Min.	All Devices -7 Max.	Units
t_{PD}	20-PT combinatorial propagation delay	—	4.4	—	4.7	—	5.8	—	7.5	ns
t_S	GLB register setup time before clock	2.2	—	2.5	—	2.9	—	4.5	—	ns
t_{ST}	GLB register setup time before clock with T-type register	2.4	—	2.7	—	3.1	—	4.7	—	ns
t_{SIR}	GLB register setup time before clock, input register path	1.0	—	1.1	—	1.3	—	1.4	—	ns
t_{SIRZ}	GLB register setup time before clock with zero hold	2.0	—	2.1	—	2.9	—	4.0	—	ns
t_H	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{HT}	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{HIR}	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.3	—	1.3	—	ns
t_{HIRZ}	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{CO}	GLB register clock-to-output delay	—	3.0	—	3.2	—	3.8	—	4.5	ns
t_R	External reset pin to output delay	—	5.0	—	6.0	—	7.5	—	9.0	ns
t_{RW}	External reset pulse duration	1.5	—	1.7	—	2.0	—	4.0	—	ns
$t_{PTOE/DIS}$	Input to output local product term output enable/disable	—	7.0	—	8.0	—	8.2	—	9.0	ns
$t_{GPTOE/DIS}$	Input to output global product term output enable/disable	—	6.5	—	7.0	—	10.0	—	10.5	ns
$t_{GOE/DIS}$	Global OE input to output enable/disable	—	4.5	—	4.5	—	5.5	—	7.0	ns
t_{CW}	Global clock width, high or low	1.0	—	1.5	—	1.8	—	2.8	—	ns
t_{GW}	Global gate width low (for low transparent) or high (for high transparent)	1.0	—	1.5	—	1.8	—	2.8	—	ns
t_{WIR}	Input register clock width, high or low	1.0	—	1.5	—	1.8	—	2.8	—	ns
f_{MAX} (Int.)[3]	Clock frequency with internal feedback	—	260	—	241	—	200	—	172	MHz
f_{MAX} (Ext.)	clock frequency with external feedback, $[1 / (t_S + t_{CO})]$	—	192	—	175	—	149	—	111	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.
2. Measured using standard switching GRP loading of 1 and 1 output switching.
3. Standard 16-bit counter using GRP feedback.

Timing v.0.8

ispMACH 4000ZE Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	All Devices				Units
		-5		-7		
		Min.	Max.	Min.	Max.	
In/Out Delays						
t_{IN}	Input Buffer Delay	—	1.05	—	1.90	ns
t_{GCLK_IN}	Global Clock Input Buffer Delay	—	1.95	—	2.15	ns
t_{GOE}	Global OE Pin Delay	—	3.00	—	4.30	ns
t_{BUF}	Delay through Output Buffer	—	1.10	—	1.30	ns
t_{EN}	Output Enable Time	—	2.50	—	2.70	ns
t_{DIS}	Output Disable Time	—	2.50	—	2.70	ns
t_{PGSU}	Input Power Guard Setup Time	—	4.30	—	5.60	ns
t_{PGH}	Input Power Guard Hold Time	—	0.00	—	0.00	ns
t_{PGPW}	Input Power Guard BIE Minimum Pulse Width	—	6.00	—	8.00	ns
t_{PGRT}	Input Power Guard Recovery Time Following BIE Dissertation	—	5.00	—	7.00	ns
Routing Delays						
t_{ROUTE}	Delay through GRP	—	2.25	—	2.50	ns
t_{PDi}	Macrocell Propagation Delay	—	0.45	—	0.50	ns
t_{MCELL}	Macrocell Delay	—	0.65	—	1.00	ns
t_{INREG}	Input Buffer to Macrocell Register Delay	—	1.00	—	1.00	ns
t_{FBK}	Internal Feedback Delay	—	0.75	—	0.30	ns
t_{ORP}	Output Routing Pool Delay	—	0.30	—	0.30	ns
Register/Latch Delays						
t_S	D-Register Setup Time (Global Clock)	0.90	—	1.25	—	ns
t_{S_PT}	D-Register Setup Time (Product Term Clock)	2.00	—	2.35	—	ns
t_H	D-Register Hold Time	2.00	—	3.25	—	ns
t_{ST}	T-Register Setup Time (Global Clock)	1.10	—	1.45	—	ns
t_{ST_PT}	T-register Setup Time (Product Term Clock)	2.20	—	2.65	—	ns
t_{HT}	T-Resister Hold Time	2.00	—	3.25	—	ns
t_{SIR}	D-Input Register Setup Time (Global Clock)	1.20	—	0.65	—	ns
t_{SIR_PT}	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	ns
t_{HIR}	D-Input Register Hold Time (Global Clock)	1.40	—	2.05	—	ns
t_{HIR_PT}	D-Input Register Hold Time (Product Term Clock)	1.10	—	1.20	—	ns
t_{COi}	Register Clock to Output/Feedback MUX Time	—	0.45	—	0.75	ns
t_{CES}	Clock Enable Setup Time	2.00	—	2.00	—	ns
t_{CEH}	Clock Enable Hold Time	0.00	—	0.00	—	ns
t_{SL}	Latch Setup Time (Global Clock)	0.90	—	1.55	—	ns
t_{SL_PT}	Latch Setup Time (Product Term Clock)	2.00	—	2.05	—	ns
t_{HL}	Latch Hold Time	2.00	—	1.17	—	ns
t_{GOi}	Latch Gate to Output/Feedback MUX Time	—	0.35	—	0.33	ns
t_{PDLi}	Propagation Delay through Transparent Latch to Output/ Feedback MUX	—	0.25	—	0.25	ns
t_{SRi}	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.95	—	0.28	ns

Switching Test Conditions

Figure 17 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 13.

Figure 17. Output Test Load, LVTTL and LVCMOS Standards

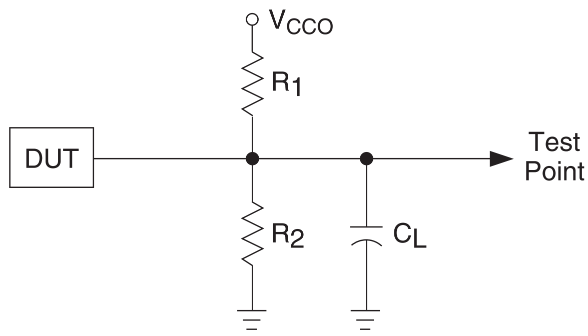


Table 13. Test Fixture Required Components

Test Condition	R_1	R_2	C_L[1]	Timing Ref.	V_{CCO}
LVCMOS I/O, (L -> H, H -> L)	106Ω	106Ω	35pF	LVCMOS 3.3 = 1.5V	LVCMOS 3.3 = 3.0V
				LVCMOS 2.5 = $\frac{V_{CCO}}{2}$	LVCMOS 2.5 = 2.3V
				LVCMOS 1.8 = $\frac{V_{CCO}}{2}$	LVCMOS 1.8 = 1.65V
				LVCMOS 1.5 = $\frac{V_{CCO}}{2}$	LVCMOS 1.5 = 1.4V
LVCMOS I/O (Z -> H)	∞	106Ω	35pF	1.5V	3.0V
LVCMOS I/O (Z -> L)	106Ω	∞	35pF	1.5V	3.0V
LVCMOS I/O (H -> Z)	∞	106Ω	5pF	V_{OH} - 0.3	3.0V
LVCMOS I/O (L -> Z)	106Ω	∞	5pF	V_{OL} + 0.3	3.0V

1. C_L includes test fixtures and probe capacitance.

ispMACH 4000ZE Power Supply and NC Connections[1]

Signal	48 TQFP[2]	64 csBGA[3, 4]	64 ucBGA[3, 4]	100 TQFP[2]
VCC	12, 36	E4, D5	E4, D5	25, 40, 75, 90
VCCO0 VCCO (Bank 0)	6	**4032ZE:** E3 **4064ZE:** E3, F4	C3, F3	13, 33, 95
VCCO1 VCCO (Bank 1)	30	**4032ZE:** D6 **4064ZE:** D6, C6	F6, A6	45, 63, 83
GND	13, 37	D4, E5	D4, D5	1, 26, 51, 76
GND (Bank 0)	5	D4, E5	D4, D5	7, 18, 32, 96
GND (Bank 1)	29	D4, E5	D4, D5	46, 57, 68, 82
NC	—	—	—	—

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.
4. All bonded grounds are connected to the following two balls, D4 and E5.

ispMACH 4032ZE and 4064ZE Logic Signal Connections: 48 TQFP

Pin Number	Bank Number	ispMACH 4032ZE	ispMACH 4064ZE
		GLB/MC/Pad	GLB/MC/Pad
1	-	TDI	TDI
2	0	A5	A8
3	0	A6	A10
4	0	A7	A11
5	0	GND (Bank 0)	GND (Bank 0)
6	0	VCCO (Bank 0)	VCCO (Bank 0)
7	0	A8	B15
8	0	A9	B12
9	0	A10	B10
10	0	A11	B8
11	-	TCK	TCK
12	-	VCC	VCC
13	-	GND	GND
14	0	A12	B6
15	0	A13	B4
16	0	A14	B2
17	0	A15	B0
18	0	CLK1/I	CLK1/I
19	1	CLK2/I	CLK2/I
20	1	B0	C0
21	1	B1	C1
22	1	B2	C2
23	1	B3	C4
24	1	B4	C6
25	-	TMS	TMS
26	1	B5	C8
27	1	B6	C10
28	1	B7	C11
29	1	GND (Bank 1)	GND (Bank 1)
30	1	VCCO (Bank 1)	VCCO (Bank 1)
31	1	B8	D15
32	1	B9	D12
33	1	B10	D10
34	1	B11	D8
35	-	TDO	TDO
36	-	VCC	VCC
37	-	GND	GND
38	1	B12	D6
39	1	B13	D4
40	1	B14	D2
41	1	B15/GOE1	D0/GOE1
42	1	CLK3/I	CLK3/I

ispMACH 4032ZE and 4064ZE Logic Signal Connections: 48 TQFP (Cont.)

Pin Number	Bank Number	ispMACH 4032ZE	ispMACH 4064ZE
		GLB/MC/Pad	GLB/MC/Pad
43	0	CLK0/I	CLK0/I
44	0	A0/GOE0	A0/GOE0
45	0	A1	A1
46	0	A2	A2
47	0	A3	A4
48	0	A4	A6

ispMACH 4032ZE and 4064ZE Logic Signal Connections: 64 csBGA

Ball Number	Bank Number	ispMACH 4032ZE	ispMACH 4064ZE
		GLB/MC/Pad	GLB/MC/Pad
B2	-	TDI	TDI
B1	0	A5	A8
C2	0	A6	A10
C1	0	A7	A11
GND*	0	GND (Bank 0)	GND (Bank 0)
C3	0	NC	A12
E3	0	VCCO (Bank 0)	VCCO (Bank 0)
D1	0	A8	B15
D2	0	NC	B14
E1	0	A9	B13
D3	0	A10	B12
F1	0	A11	B11
E2	0	NC	B10
G1	0	NC	B9
F2	0	NC	B8
H1	-	TCK	TCK
E4	-	VCC	VCC
GND*	-	GND	GND
G2	0	A12	B6
H2	0	NC	B5
H3	0	A13	B4
GND*	0	NC	GND (Bank 0)
F4	0	NC	VCCO (Bank 0)
G3	0	A14	B3
F3	0	NC	B2
H4	0	A15	B0
G4	0	CLK1/I	CLK1/I
H5	1	CLK2/I	CLK2/I
F5	1	B0	C0
G5	1	B1	C1
G6	1	B2	C2
H6	1	B3	C4
F6	1	B4	C5
H7	1	NC	C6
H8	-	TMS	TMS
G7	1	B5	C8
F7	1	B6	C10
G8	1	B7	C11
GND*	1	GND (Bank 0)	GND (Bank 1)
F8	1	NC	C12
D6	1	VCCO (Bank 1)	VCCO (Bank 1)
E8	1	B8	D15

ispMACH 4064ZE Logic Signal Connections: 64 ucBGA

Ball Number	Bank Number	GLB/MC/Pad
A1	-	TDI
B1	0	A8
B2	0	A10
B3	0	A11
GND*	0	GND (Bank 0)
C1	0	A12
C3	0	VCCO (Bank 0)
C2	0	B15
D1	0	B14
D2	0	B13
D3	0	B12
E1	0	B11
E2	0	B10
E3	0	B9
F1	0	B8
F2	-	TCK
E4	-	VCC
GND*	-	GND
H2	0	B6
H1	0	B5
G1	0	B4
GND*	0	GND (Bank 0)
F3	0	VCCO (Bank 0)
G2	0	B3
G3	0	B2
H3	0	B0
G4	0	CLK1/I
F4	1	CLK2/I
H4	1	C0
H5	1	C1
G5	1	C2
H6	1	C4
H7	1	C5
H8	1	C6
G8	-	TMS
G7	1	C8
G6	1	C10
F8	1	C11
GND*	1	GND (Bank 1)
F7	1	C12
F6	1	VCCO (Bank 1)
F5	1	D15
E8	1	D14

ispMACH 4064ZE, 4128ZE and 4256ZE Logic Signal Connections: 100 TQFP (Cont.)

Pin Number	Bank Number	LC4064ZE	LC4128ZE	LC4256ZE
		GLB/MC/Pad	GLB/MC/Pad	GLB/MC/Pad
42	1	C1	E2	I6
43	1	C2	E4	I10
44	1	C3	E6	I12
45	1	VCCO (Bank 1)	VCCO (Bank 1)	VCCO (Bank 1)
46	1	GND (Bank 1)	GND (Bank 1)	GND (Bank 1)
47	1	C4	E8	J2
48	1	C5	E10	J6
49	1	C6	E12	J10
50	1	C7	E14	J12
51	-	GND	GND	GND
52	-	TMS	TMS	TMS
53	1	C8	F0	K12
54	1	C9	F2	K10
55	1	C10	F4	K6
56	1	C11	F6	K2
57	1	GND (Bank 1)	GND (Bank 1)	GND (Bank 1)
58	1	C12	F8	L12
59	1	C13	F10	L10
60	1	C14	F12	L6
61	1	C15	F13	L4
62*	1	I	I	I
63	1	VCCO (Bank 1)	VCCO (Bank 1)	VCCO (Bank 1)
64	1	D15	G14	M4
65	1	D14	G12	M6
66	1	D13	G10	M10
67	1	D12	G8	M12
68	1	GND (Bank 1)	GND (Bank 1)	GND (Bank 1)
69	1	D11	G6	N2
70	1	D10	G5	N6
71	1	D9	G4	N10
72	1	D8	G2	N12
73*	1	I	I	I
74	-	TDO	TDO	TDO
75	-	VCC	VCC	VCC
76	-	GND	GND	GND
77*	1	I	I	I
78	1	D7	H13	O12
79	1	D6	H12	O10
80	1	D5	H10	O6
81	1	D4	H8	O2
82	1	GND (Bank 1)	GND (Bank 1)	GND (Bank 1)

ispMACH 4128ZE Logic Signal Connections: 132 ucBGA

Ball Number	Bank Number	GLB/MC/Pad
GND*	-	GND
A1	-	TDI
B1	0	VCCO (Bank 0)
D3	0	B0
C1	0	B1
D2	0	B2
D1	0	B4
E4	0	B5
F3	0	B6
E2	0	GND (Bank 0)
E1	0	B8
E3	0	B9
F4	0	B10
G4	0	B12
F2	0	B13
G3	0	B14
H4	0	VCCO (Bank 0)
F1	0	C14
G2	0	C13
G1	0	C12
H3	0	C10
J4	0	C9
H1	0	C8
H2	0	GND (Bank 0)
J3	0	C6
J1	0	C5
J2	0	C4
K3	0	C2
K2	0	C1
K1	0	C0
L2	0	VCCO (Bank 0)
L1	-	TCK
M1	-	VCC
GND*	-	GND
L3	0	D14
M2	0	D13
K4	0	D12
M3	0	D10
K5	0	D9
L4	0	D8
M4	0	GND (Bank 0)
J5	0	VCCO (Bank 0)
L5	0	D6

ispMACH 4064ZE, 4128ZE and 4256ZE Logic Signal Connections: 144 csBGA

Ball Number	Bank Number	LC4064ZE	LC4128ZE	LC4256ZE
		GLB/MC/Pad	GLB/MC/Pad	GLB/MC/Pad
F6	-	GND	GND	GND
A1	-	TDI	TDI	TDI
E4	0	NC Ball	VCCO (Bank 0)	VCCO (Bank 0)
B2	0	NC Ball	B0	C12
B1	0	NC Ball	B1	C10
C3	0	A8	B2	C8
C2	0	A9	B4	C6
C1	0	A10	B5	C4
D1	0	A11	B6	C2
G5	0	GND (Bank 0)	GND (Bank 0)	GND (Bank 0)
D2	0	NC Ball	NC Ball	D14
D3	0	NC Ball	NC Ball	D12
E1	0	NC Ball	B8	D10
E2	0	A12	B9	D8
F2	0	A13	B10	D6
D4	0	A14	B12	D4
F1	0	A15	B13	D2
F3*	0	I	B14	D0
F4	0	VCCO (Bank 0)	VCCO (Bank 0)	VCCO (Bank 0)
G1	0	B15	C14	E0
E3	0	B14	C13	E2
G2	0	B13	C12	E4
G3	0	B12	C10	E6
H1	0	NC Ball	C9	E8
H3	0	NC Ball	C8	E10
H2	0	NC Ball	NC Ball	E12
H4	0	GND (Bank 0)	GND (Bank 0)	GND (Bank 0)
J1	0	B11	C6	F2
J3	0	B10	C5	F4
J2	0	B9	C4	F6
K1	0	B8	C2	F8
K2*	0	I	C1	F10
L1	0	NC Ball	C0	F12
G4	0	NC Ball	VCCO (Bank 0)	VCCO (Bank 0)
L2	-	TCK	TCK	TCK
H5	-	VCC	VCC	VCC
G6	-	GND	GND	GND
M1	0	NC Ball	NC Ball	G14
K3	0	NC Ball	NC Ball	G12
M2	0	NC Ball	D14	G10
L3*	0	I	D13	G8

ispMACH 4064ZE, 4128ZE and 4256ZE Logic Signal Connections: 144 csBGA (Cont.)

Ball Number	Bank Number	LC4064ZE	LC4128ZE	LC4256ZE
		GLB/MC/Pad	GLB/MC/Pad	GLB/MC/Pad
J4	0	B7	D12	G6
K4	0	B6	D10	G4
M3	0	B5	D9	G2
L4	0	B4	D8	G0
H6	0	GND (Bank 0)	GND (Bank 0)	GND (Bank 0)
J5	0	VCCO (Bank 0)	VCCO (Bank 0)	VCCO (Bank 0)
M4	0	NC Ball	D6	H12
L5	0	NC Ball	D5	H10
K5	0	B3	D4	H8
J6	0	B2	D2	H6
M5	0	B1	D1	H4
K6	0	B0	D0	H2
L6	0	CLK1/I	CLK1/I	CLK1/I
H7	1	NC Ball	GND (Bank 1)	GND (Bank 1)
M6	1	CLK2/I	CLK2/I	CLK2/I
H8	-	VCC	VCC	VCC
K7	1	C0	E0	I2
M7	1	C1	E1	I4
L7	1	C2	E2	I6
J7	1	C3	E4	I8
L8	1	NC Ball	E5	I10
M8	1	NC Ball	E6	I12
J8	1	VCCO (Bank 1)	VCCO (Bank 1)	VCCO (Bank 1)
J9	1	GND (Bank 1)	GND (Bank 1)	GND (Bank 1)
M9	1	C4	E8	J2
L9	1	C5	E9	J4
K8	1	C6	E10	J6
M10	1	C7	E12	J8
L10	1	NC Ball	E13	J10
K9	1	NC Ball	E14	J12
M11	1	NC Ball	NC Ball	J14
G7	-	GND	GND	GND
M12	-	TMS	TMS	TMS
H9	1	NC Ball	VCCO (Bank 1)	VCCO (Bank 1)
L12	1	NC Ball	F0	K12
L11	1	NC Ball	F1	K10
K10	1	C8	F2	K8
K12	1	C9	F4	K6
J10	1	C10	F5	K4
K11	1	C11	F6	K2
G8	1	GND (Bank 1)	GND (Bank 1)	GND (Bank 1)

ispMACH 4064ZE, 4128ZE and 4256ZE Logic Signal Connections: 144 csBGA (Cont.)

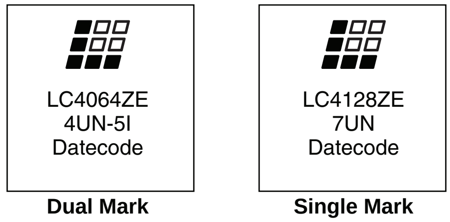
Ball Number	Bank Number	LC4064ZE	LC4128ZE	LC4256ZE
		GLB/MC/Pad	GLB/MC/Pad	GLB/MC/Pad
C7	1	CLK3/I	CLK3/I	CLK3/I
E6	0	NC Ball	GND (Bank 0)	GND (Bank 0)
A7	0	CLK0/I	CLK0/I	CLK0/I
E5	-	VCC	VCC	VCC
D6	0	A0/GOE0	A0/GOE0	A2/GOE0
B6	0	A1	A1	A4
A6	0	A2	A2	A6
C6	0	A3	A4	A8
B5	0	NC Ball	A5	A10
A5	0	NC Ball	A6	A12
D5	0	VCCO (Bank 0)	VCCO (Bank 0)	VCCO (Bank 0)
F5	0	GND (Bank 0)	GND (Bank 0)	GND (Bank 0)
A4	0	A4	A8	B2
B4	0	A5	A9	B4
C5	0	A6	A10	B6
A3	0	A7	A12	B8
C4	0	NC Ball	A13	B10
B3	0	NC Ball	A14	B12
A2	0	NC Ball	NC Ball	B14

* This pin is input only for the LC4064ZE.

ispMACH 4128ZE and 4256ZE Logic Signal Connections: 144 TQFP (Cont.)

Pin Number	Bank Number	LC4128ZE	LC4256ZE
		GLB/MC/Pad	GLB/MC/Pad
86	1	F12	L8
87	1	F13	L6
88	1	F14	L4
89*	1	NC	I
90	1	GND (Bank 1)	NC
91	1	VCCO (Bank 1)	VCCO (Bank 1)
92*	1	NC	I
93	1	G14	M2
94	1	G13	M4
95	1	G12	M6
96	1	G10	M8
97	1	G9	M10
98	1	G8	M12
99	1	GND (Bank 1)	GND (Bank 1)
100	1	G6	N2
101	1	G5	N4
102	1	G4	N6
103	1	G2	N8
104	1	G1	N10
105	1	G0	N12
106	1	VCCO (Bank 1)	VCCO (Bank 1)
107	-	TDO	TDO
108	-	VCC	VCC
109	-	GND	GND
110*	1	NC	I
111	1	H14	O12
112	1	H13	O10
113	1	H12	O8
114	1	H10	O6
115	1	H9	O4
116	1	H8	O2
117*	1	NC	I
118	1	GND (Bank 1)	GND (Bank 1)
119	1	VCCO (Bank 1)	VCCO (Bank 1)
120	1	H6	P12
121	1	H5	P10
122	1	H4	P8
123	1	H2	P6
124	1	H1	P4
125	1	H0/GOE1	P2/GOE1
126	1	CLK3/I	CLK3/I
127	0	GND (Bank 0)	GND (Bank 0)
128	0	CLK0/I	CLK0/I

Figure 20. Mark Format for 64 ucBGA and 132 ucBGA Packages



Lead-Free Packaging

Commercial

Device	Part Number	Macrocells	Voltage	t_{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032ZE	LC4032ZE-4TN48C	32	1.8	4.4	Lead-Free TQFP	48	32	C
	LC4032ZE-5TN48C	32	1.8	5.8	Lead-Free TQFP	48	32	C
	LC4032ZE-7TN48C	32	1.8	7.5	Lead-Free TQFP	48	32	C
	LC4032ZE-4MN64C	32	1.8	4.4	Lead-Free csBGA	64	32	C
	LC4032ZE-5MN64C	32	1.8	5.8	Lead-Free csBGA	64	32	C
	LC4032ZE-7MN64C	32	1.8	7.5	Lead-Free csBGA	64	32	C
LC4064ZE	LC4064ZE-4TN48C	64	1.8	4.7	Lead-Free TQFP	48	32	C
	LC4064ZE-5TN48C	64	1.8	5.8	Lead-Free TQFP	48	32	C
	LC4064ZE-7TN48C	64	1.8	7.5	Lead-Free TQFP	48	32	C
	LC4064ZE-4TN100C	64	1.8	4.7	Lead-Free TQFP	100	64	C
	LC4064ZE-5TN100C	64	1.8	5.8	Lead-Free TQFP	100	64	C
	LC4064ZE-7TN100C	64	1.8	7.5	Lead-Free TQFP	100	64	C
	LC4064ZE-4MN64C	64	1.8	4.7	Lead-Free csBGA	64	48	C
	LC4064ZE-5MN64C	64	1.8	5.8	Lead-Free csBGA	64	48	C
	LC4064ZE-7MN64C	64	1.8	7.5	Lead-Free csBGA	64	48	C
	LC4064ZE-4MN144C	64	1.8	4.7	Lead-Free csBGA	144	64	C
	LC4064ZE-5MN144C	64	1.8	5.8	Lead-Free csBGA	144	64	C
	LC4064ZE-7MN144C	64	1.8	7.5	Lead-Free csBGA	144	64	C
LC4128ZE	LC4128ZE-5TN100C	128	1.8	5.8	Lead-Free TQFP	100	64	C
	LC4128ZE-7TN100C	128	1.8	7.5	Lead-Free TQFP	100	64	C
	LC4128ZE-5TN144C	128	1.8	5.8	Lead-Free TQFP	144	96	C
	LC4128ZE-7TN144C	128	1.8	7.5	Lead-Free TQFP	144	96	C
	LC4128ZE-5UMN132C	128	1.8	5.8	Lead-Free ucBGA	132	96	C
	LC4128ZE-7UMN132C	128	1.8	7.5	Lead-Free ucBGA	132	96	C
	LC4128ZE-5MN144C	128	1.8	5.8	Lead-Free csBGA	144	96	C
	LC4128ZE-7MN144C	128	1.8	7.5	Lead-Free csBGA	144	96	C
LC4256ZE	LC4256ZE-5TN100C	256	1.8	5.8	Lead-Free TQFP	100	64	C
	LC4256ZE-7TN100C	256	1.8	7.5	Lead-Free TQFP	100	64	C
	LC4256ZE-5TN144C	256	1.8	5.8	Lead-Free TQFP	144	96	C
	LC4256ZE-7TN144C	256	1.8	7.5	Lead-Free TQFP	144	96	C
	LC4256ZE-5MN144C	256	1.8	5.8	Lead-Free csBGA	144	108	C
	LC4256ZE-7MN144C	256	1.8	7.5	Lead-Free csBGA	144	108	C

Industrial

Device	Part Number	Macrocells	Voltage	t_{PD}	Package	Pin/Ball Count	I/O	Grade
LC4032ZE	LC4032ZE-5TN48I	32	1.8	5.8	Lead-Free TQFP	48	32	I
	LC4032ZE-7TN48I	32	1.8	7.5	Lead-Free TQFP	48	32	I
	LC4032ZE-5MN64I	32	1.8	5.8	Lead-Free csBGA	64	32	I
	LC4032ZE-7MN64I	32	1.8	7.5	Lead-Free csBGA	64	32	I
LC4064ZE	LC4064ZE-5TN48I	64	1.8	5.8	Lead-Free TQFP	48	32	I
	LC4064ZE-7TN48I	64	1.8	7.5	Lead-Free TQFP	48	32	I
	LC4064ZE-5TN100I	64	1.8	5.8	Lead-Free TQFP	100	64	I
	LC4064ZE-7TN100I	64	1.8	7.5	Lead-Free TQFP	100	64	I
	LC4064ZE-5MN64I	64	1.8	5.8	Lead-Free csBGA	64	48	I
	LC4064ZE-7MN64I	64	1.8	7.5	Lead-Free csBGA	64	48	I
	LC4064ZE-5UMN64I	64	1.8	5.8	Lead-Free ucBGA	64	48	I
	LC4064ZE-7UMN64I	64	1.8	7.5	Lead-Free ucBGA	64	48	I
	LC4064ZE-5MN144I	64	1.8	5.8	Lead-Free csBGA	144	64	I
	LC4064ZE-7MN144I	64	1.8	7.5	Lead-Free csBGA	144	64	I
LC4128ZE	LC4128ZE-7TN100I	128	1.8	7.5	Lead-Free TQFP	100	64	I
	LC4128ZE-7UMN132I	128	1.8	7.5	Lead-Free ucBGA	132	96	I
	LC4128ZE-7TN144I	128	1.8	7.5	Lead-Free TQFP	144	96	I
	LC4128ZE-7MN144I	128	1.8	7.5	Lead-Free csBGA	144	96	I
LC4256ZE	LC4256ZE-7TN100I	256	1.8	7.5	Lead-Free TQFP	100	64	I
	LC4256ZE-7TN144I	256	1.8	7.5	Lead-Free TQFP	144	96	I
	LC4256ZE-7MN144I	256	1.8	7.5	Lead-Free csBGA	144	108	I

1. Contact factory for product availability.

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 4000ZE family:

- TN1168, ispMACH 4000ZE Timing Model Design and Usage Guidelines
- TN1174, Advanced Features of the ispMACH 4000ZE Family
- TN1187, Power Estimation in ispMACH 4000ZE Devices
- Package Diagrams

Technical Support Assistance

Hotline: 1-800-LATTICE (North America)
+1-503-268-8001 (Outside North America)
e-mail: techsupport@latticesemi.com
Internet: www.latticesemi.com